PCN Number: 20200129001 PCN Date: Mar. 18, 2020							
Title: Datasheet for LMK04228							
Cu	stomer Contact: PCN Manac	er		C	)e	pt: Q	uality Services
Ch	ange Type:						
	Assembly Site		Design			Wafer Bu	imp Site
	Assembly Process	$\boxtimes$	Data Sheet			Wafer Bu	mp Material
	Assembly Materials		Part number change			Wafer Bu	mp Process
	Mechanical Specification		Test Site			Wafer Fa	b Site
	Packing/Shipping/Labeling		Test Process				b Materials
						Wafer Fa	b Process
Notification Details							
De	scription of Change:						
	xas Instruments Incorporated is				no	tification.	
	e product datasheet(s) is being			۷.			
١h	e following change history provi	des	further details.				
-	TEXAS INSTRUMENTS						LMK04228
	INSTRUMENTS			SN/	AS6	89A-OCTOBER	2017-REVISED JULY 2019
Cł	anges from Original (October 2017) to	Rev	ision A				Page
	Changed the data sheet release status fi	om	custom to catalog				
	Changed the data sheet release status from custom to catalog						
	Deleted reference to dynamic delay (unsupported) Updated default output table note						
•							
•							
	Updated delay circuit descriptions for improved clarity						
	Deleted reference to dynamic delay (unsupported)						
	Deleted reference to dynamic delay, bypass mode in clock output block diagram (unsupported)						
	Clarified requirements for unused registers in recommended programming sequence.						
	Added registers 0x171 and 0x172 to default register programming						
	Deleted references to dynamic delay in register map (unsupported)						
	Corrected CLKINX_R register size in register map						
2	Deleted reference to DCLKoutX_MUX bypass mode (unsupported)						
	Deleted reference to dynamic delay (unsupported)						
	Deleted reference to dynamic delay (unsupported)						

•	Updated missing cross-reference	. 49
•	Corrected CLKinX_R register length	. 59
•	Corrected PLL1_N register length	. 60
•	Corrected PLL2_R register length	. 64
•	Split PLL2_FCAL_DIS and PLL2_N register tables into separate definitions	. 66
•	Added register 0x171 and 0x172 to register descriptions	. 72
•	Corrected RB_PLL1_LD and RB_PLL2_LD polarity	. 73
•	Added note clarifying PLL1_WND_SIZE and impact on holdover exit	. 75
•	Changed references to deprecated software tools to point to TICS Pro	. 78
•	Removed application curves section	. 79
•	Deleted unused column in typical current consumption table	. 80
•	Fixed truncated layout example image	. 82
•	Deleted links to deprecated software tools	. 83
Th	ne datasheet number will be changing.	

Device Family	Change From:	Change To:
LMK04228	SNAS689	SNAS689A

These changes may be reviewed at the datasheet links provided.

## http://www.ti.com/product/LMK04228

#### **Reason for Change:**

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

## **Changes to product identification resulting from this PCN:**

#### None.

# Product Affected:

LMK04228NKDR LMK04228NKDT

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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